STP14N80K5



N-channel 800 V, 0.400 Ω typ., 12 A MDmesh™ K5 Power MOSFET in a TO-220 package

Datasheet - production data

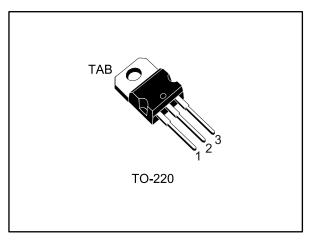
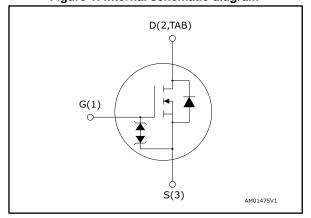


Figure 1: Internal schematic diagram



Features

| Order code | V _{DS} | R _{DS(on)} max. | I _D |
|------------|-----------------|--------------------------|----------------|
| STP14N80K5 | 800 V | 0.445 Ω | 12 A |

- Industry's lowest R_{DS(on)} x area
- Industry's best FoM (figure of merit)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This very high voltage N-channel Power MOSFET is designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

| Order code | Marking | Package | Packing |
|------------|---------|---------|---------|
| STP14N80K5 | 14N80K5 | TO-220 | Tube |

Contents STP14N80K5

Contents

| 1 | Electric | al ratings | 3 |
|---|----------|-------------------------------------|----|
| 2 | Electric | cal characteristics | 4 |
| | 2.1 | Electrical characteristics (curves) | 6 |
| 3 | Test cir | cuits | 9 |
| 4 | Packag | e information | 10 |
| | 4.1 | TO-220 type A package information | 11 |
| 5 | Revisio | n history | 13 |

STP14N80K5 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
|-------------------------------|---|-------------|------|
| V _{GS} | Gate-source voltage | ± 30 | V |
| I_D | Drain current (continuous) at T _C = 25 °C | 12 | Α |
| I _D | Drain current (continuous) at T _C = 100 °C | 7.4 | Α |
| I _D ⁽¹⁾ | Drain current (pulsed) | 48 | Α |
| P _{TOT} | Total dissipation at T _C = 25 °C | 130 | W |
| dv/dt (2) | Peak diode recovery voltage slope | 4.5 | \ |
| dv/dt (3) | MOSFET dv/dt ruggedness | 50 | V/ns |
| T _{stg} | Storage temperature range | 55 to 150 | °C |
| TJ | Operating junction temperature range | - 55 to 150 | |

Notes:

Table 3: Thermal data

| Symbol Parameter | | Value | Unit |
|-----------------------|---------------------------------|-------|------|
| R _{thj-case} | 0.96 | °C/W | |
| R _{thj-amb} | Thermal resistance junction-amb | 62.5 | °C/W |

Table 4: Avalanche characteristics

| Symbol | Parameter | Value | Unit |
|-----------------|--|-------|------|
| I _{AR} | Avalanche current, repetitive or not repetitive (pulse width limited by T_{jmax}) | 4 | А |
| E _{AS} | Single pulse avalanche energy (starting Tj = 25 °C, $I_D = I_{AR}$, $V_{DD} = 50 \text{ V}$) | 270 | mJ |

 $[\]ensuremath{^{(1)}}\mbox{Pulse}$ width limited by safe operating area.

 $^{^{(2)}}$ I_{SD} \leq 12 A, di/dt \leq 100 A/ μ s; V_{DS(peak)} < V(BR)DSS,V_{DD}= 640 V

 $^{^{(3)}}V_{DS} \le 640 \text{ V}$

Electrical characteristics STP14N80K5

2 Electrical characteristics

T_C = 25 °C unless otherwise specified

Table 5: On/off-state

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|---------------------|-----------------------------------|--|------|-------|-------|------|
| $V_{(BR)DSS}$ | Drain-source breakdown voltage | $V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$ | 800 | | | V |
| | | $V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$ | | | 1 | μΑ |
| I _{DSS} | Zero gate voltage drain current | $V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$ $T_{C} = 125 \text{ °C}^{(1)}$ | | | 50 | μΑ |
| I _{GSS} | Gate body leakage current | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ±10 | μΑ |
| V _{GS(th)} | Gate threshold voltage | $V_{DS} = V_{GS}, I_{D} = 100 \mu A$ | 3 | 4 | 5 | V |
| R _{DS(on)} | Static drain-source on-resistance | $V_{GS} = 10 \text{ V}, I_D = 6 \text{ A}$ | | 0.400 | 0.445 | Ω |

Notes:

Table 6: Dynamic

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|-----------------------------------|---------------------------------------|--|------|------|------|------|
| C _{iss} | Input capacitance | | • | 620 | - | pF |
| Coss | Output capacitance | $V_{DS} = 100 \text{ V}, f = 1 \text{ MHz},$ $V_{GS} = 0 \text{ V}$ | 1 | 60 | - | pF |
| C_{rss} | Reverse transfer capacitance | VG5 - 0 V | ı | 0.8 | - | pF |
| C _{o(tr)} ⁽¹⁾ | Equivalent capacitance time related | V - 0 to 640 V V - 0 V | 1 | 107 | - | pF |
| C _{o(er)} ⁽²⁾ | Equivalent capacitance energy related | $V_{DS} = 0$ to 640 V, $V_{GS} = 0$ V | ı | 39 | - | pF |
| R_g | Intrinsic gate resistance | $f = 1 \text{ MHz}$, $I_D = 0 \text{ A}$ | • | 6.5 | - | Ω |
| Q_g | Total gate charge | $V_{DD} = 640 \text{ V}, I_D = 12 \text{ A}$ | - | 22 | - | nC |
| Q _{gs} | Gate-source charge | V _{GS} = 10 V | - | 4.3 | - | nC |
| Q_{gd} | Gate-drain charge | (see Figure 16: "Test circuit for gate charge behavior" | - | 16.5 | - | nC |

Notes:

⁽¹⁾Defined by design, not subject to production test.

 $^{^{(1)}}$ Time related is defined as a constant equivalent capacitance giving the same charging time as Coss when V_{DS} increases from 0 to 80% V_{DSS}

 $^{^{(2)}}$ Energy related is defined as a constant equivalent capacitance giving the same stored energy as Coss when V_{DS} increases from 0 to 80% V_{DSS}

Table 7: Switching times

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|---------------------|---------------------|--|------|------|------|------|
| t _{d(on)} | Turn-on delay time | V_{DD} = 400 V, I_{D} =6 A, R_{G} = 4.7 Ω | ı | 12.5 | 1 | ns |
| t _r | Rise time | $V_{GS} = 10 \text{ V}$ | ı | 8 | ı | ns |
| t _{d(off)} | Turn-off delay time | see (Figure 15: "Test circuit for resistive load switching times" and | - | 33 | - | ns |
| t _f | Fall time | Figure 20: "Switching time waveform") | - | 10 | - | ns |

Table 8: Source-drain diode

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|---------------------------------|-------------------------------|--|------|------|------|------|
| I _{SD} | Source-drain current | | 1 | | 12 | Α |
| I _{SDM} ⁽¹⁾ | Source-drain current (pulsed) | | - | | 48 | Α |
| V _{SD} ⁽²⁾ | Forward on voltage | I _{SD} = 12 A, V _{GS} = 0 V | 1 | | 1.5 | V |
| t _{rr} | Reverse recovery time | I _{SD} = 12 A, di/dt = 100 A/μs, | 1 | 365 | | ns |
| Q _{rr} | Reverse recovery charge | V _{DD} = 60 V (see Figure 17: "Test circuit for inductive load switching and diode recovery times") | - | 4.77 | | μC |
| I _{RRM} | Reverse recovery current | | - | 26 | | Α |
| t _{rr} | Reverse recovery time | I _{SD} = 12 A, di/dt = 100 A/μs, | - | 485 | | ns |
| Q _{rr} | Reverse recovery charge | V _{DD} = 60 V, T _j = 150 °C (see Figure 17: "Test circuit for inductive load switching and diode recovery times") | - | 5.85 | | μC |
| I _{RRM} | Reverse recovery current | | - | 24 | | Α |

Notes

Table 9: Gate-source Zener diode

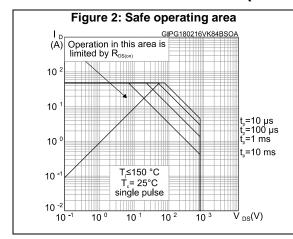
| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|---------------|-------------------------------|---------------------------------|------|------|------|------|
| $V_{(BR)GSO}$ | Gate-source breakdown voltage | I_{GS} = ± 1mA, I_{D} = 0 A | 30 | - | - | V |

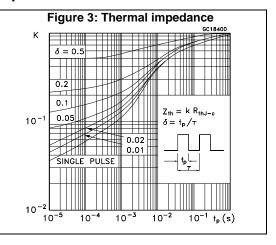
The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.

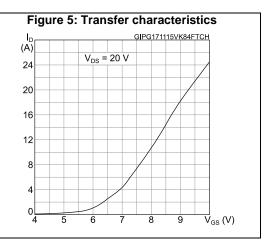
⁽¹⁾Pulse width limited by safe operating area

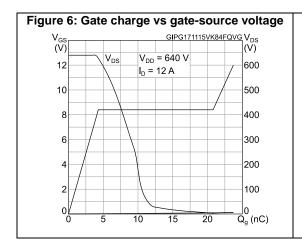
 $^{^{(2)}}$ Pulsed: pulse duration = 300 μ s, duty cycle 1.5%

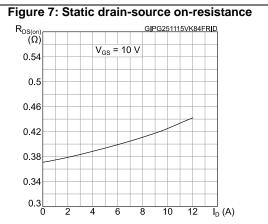
2.2 Electrical characteristics (curves)











STP14N80K5 Electrical characteristics

Figure 8: Capacitance variations

C
(pF)

103

102

101

f = 1 MHz

C
C
RSS

Figure 9: Normalized gate threshold voltage vs temperature

V GS(th) GIPG171115VK84FVTH

1.2

1.0

0.8

0.6

0.4

-75

-25

25

75

125

T (°C)

Figure 10: Normalized on-resistance vs temperature

R_{DS(on)} GIPG171115VK84FRON (norm.)

2.6

2.2

1.8

1.4

1.0

0.6

0.2

-75

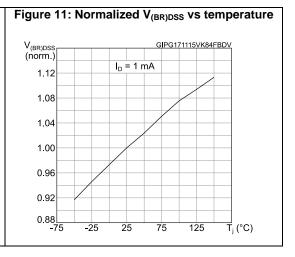
-25

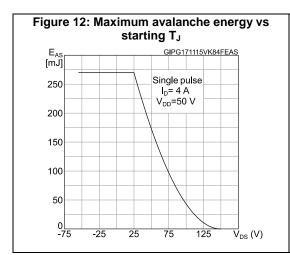
25

75

125

T_j (°C)





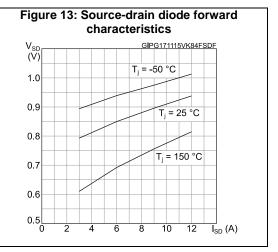


Figure 14: Maximum avalanche energy vs starting T_J

E_{OSS}
(µJ)
10
8
6
4
2
0
100 200 300 400 500 600 700 V DS(V)

STP14N80K5 Test circuits

3 Test circuits

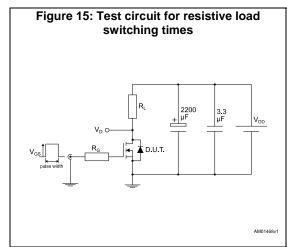
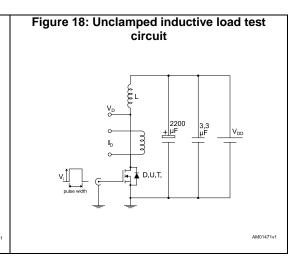
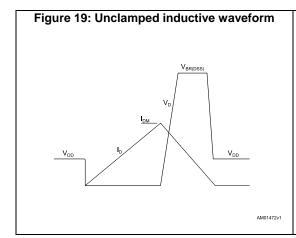


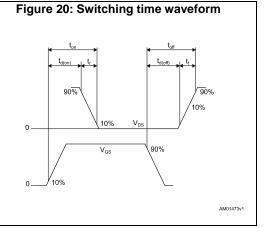
Figure 16: Test circuit for gate charge behavior

12 V 47 kΩ 100 nF 100

Figure 17: Test circuit for inductive load switching and diode recovery times







4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

STP14N80K5 Package information

4.1 TO-220 type A package information

Figure 21: TO-220 type A package outline

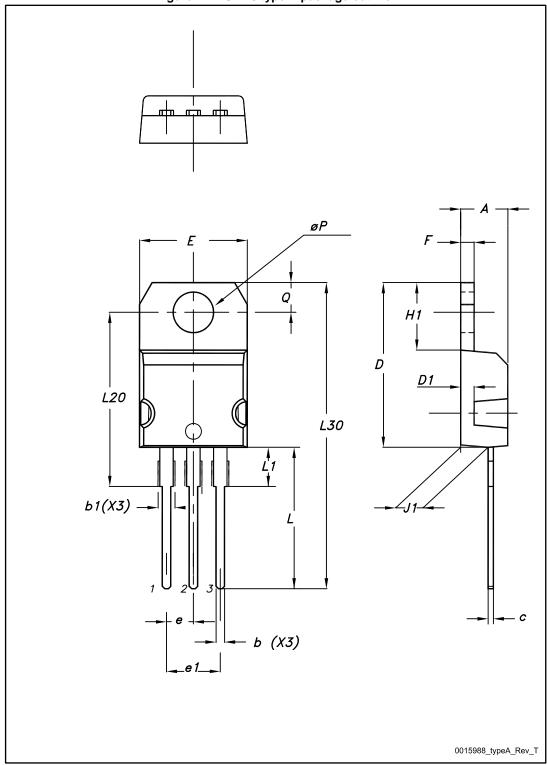


Table 10: TO-220 type A mechanical data

| Dim | mm | | | | |
|------|-------|-------|-------|--|--|
| Dim. | Min. | Тур. | Max. | | |
| А | 4.40 | | 4.60 | | |
| b | 0.61 | | 0.88 | | |
| b1 | 1.14 | | 1.70 | | |
| С | 0.48 | | 0.70 | | |
| D | 15.25 | | 15.75 | | |
| D1 | | 1.27 | | | |
| E | 10 | | 10.40 | | |
| е | 2.40 | | 2.70 | | |
| e1 | 4.95 | | 5.15 | | |
| F | 1.23 | | 1.32 | | |
| H1 | 6.20 | | 6.60 | | |
| J1 | 2.40 | | 2.72 | | |
| L | 13 | | 14 | | |
| L1 | 3.50 | | 3.93 | | |
| L20 | | 16.40 | | | |
| L30 | | 28.90 | | | |
| øΡ | 3.75 | | 3.85 | | |
| Q | 2.65 | | 2.95 | | |

STP14N80K5 Revision history

5 Revision history

Table 11: Document revision history

| Date | Revision | Changes |
|-------------|----------|----------------|
| 04-Mar-2016 | 1 | First release. |

IMPORTANT NOTICE - PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2016 STMicroelectronics - All rights reserved

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by STMicroelectronics manufacturer:

Other Similar products are found below:

614233C 648584F IRFD120 JANTX2N5237 FCA20N60_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L SBVS138LT1G 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C BUK954R8-60E DMN3404LQ-7 NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 DMN2080UCB4-7 TK10A80W,S4X(S SSM6P69NU,LF DMP22D4UFO-7B